

# TeCK Fund

## Letter of Intent Application

Please do not exceed two pages in length. All submitted LOIs will be reviewed by the TeCK Fund Screening Committee. Successful applicants will be asked to submit a six page formal proposal. Rejected applicants will receive comments from the Committee and will be encouraged to reapply.

**Project Title:**

**Project Members:**

**Lead Applicant Contact Information:**

Email:

Phone:

**Have the team members participated in I-Corps@Ohio or other I-Corps sites program?**

Yes  No

**Has a spin-off company been created?**

Yes  No

Spinoff Company Name:

**Amount Requested:** (between \$25,000 and \$50,000)

**Please briefly describe the product or process:**

**Intellectual Property status if known:**

**By answering the questions below, please identify the Value Proposition of this project.**

Why will customers buy this product or process?

Where will you find potential customers?

What problems does this product or process solve?

What makes this product or process unique?

What competitive advantage does this product or process have over existing products?

**Please describe the market opportunity, including size of the market or submarket:**

**Have you collected input from potential customers or do you have a plan for collecting this input? Please provide details:**

**The TeCK Fund will provide funding for third party validation, prototype development and scale up, expansion of business plans, mapping of regulatory pathways, product development, and identification of start-ups to license the technology. Please describe how the funds will be used:**